# **MOSFET** – N-Channel, SUPERFET<sup>®</sup> II, FRFET<sup>®</sup>

# 650 V, 76 A, 41 m $\Omega$

# FCH041N65EFL4

#### Description

SuperFET II Mosfet is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as PFC, server / telecom power, FPD TV power, ATX power and industrial power applications. SuperFET II FREFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

#### Features

- Typ. R<sub>DS(on)</sub> = 36 mΩ
- 700 V @  $T_J = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 229 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 631 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

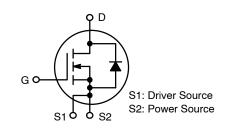
- AC-DC Power Supply
- LCD/LED/PDP TV
- Solar Inverter
- Telecom / Server Power Supplies



# **ON Semiconductor®**

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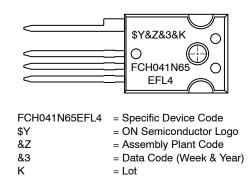
V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	41 mΩ @ 10 V	76 A



N-CHANNEL MOSFET



#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		650	V	
V <sub>GSS</sub>	Gate to Source Voltage - DC		±20	V	
		– AC (f > 1 Hz)	±30		
I <sub>D</sub>	Drain Current:	– Continuous (T <sub>C</sub> = 25°C)	76	A	
		– Continuous (T <sub>C</sub> = 100°C)	48.1		
I <sub>DM</sub>	Drain Current:	- Pulsed (Note 1)	228	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		2025	mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)		15	A	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		5.95	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	595	W	
	– Derate Above 25°C		4.76	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to + 150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1	/8" from Case for 5 seconds	300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 15 \text{ A}, \text{ R}_{G} = 25 \Omega$ , starting  $T_{J} = 25 \text{ °C}$ . 3.  $I_{SD} \le 38 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 380 \text{ V}$ , starting  $T_{J} = 25 \text{ °C}$ .

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH041N65EFL4	FCH041N65EF	TO-247 4L	Tube	N/A	N/A	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FCH041N65EFL4	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
FF CHARA	ACTERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 10 mA, T <sub>J</sub> = 25°C	650	-	-	V
		$V_{GS}$ = 0 V, $I_{D}$ = 10 mA, $T_{J}$ = 150°C	700	-	-	
$\Delta {\sf BV}_{\sf DSS}$ / $\Delta {\sf T}_{\sf J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, Referenced to 25°C	-	0.72	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V	-	-	10	μA
		$V_{DS}$ = 520 V, $T_{C}$ = 125 °C	-	145	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	-	-	±100	nA

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 7.6 \text{ mA}$	3	_	5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 38 A	_	36	4	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 38 \text{ A}$	-	71.7	-	S

## DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, f = 1 MHz	-	9446	12560	pF
C <sub>oss</sub>	Output Capacitance		-	366	490	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	35	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	197	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	-	631	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	229	298	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	-	50	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	90	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω

SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A},$	-	55	120	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω (Note 4)	-	25	60	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	169	348	ns
t <sub>f</sub>	Turn-Off Fall Time		-	18	46	ns

#### DRAIN-SOURCE DIODE CHARACTERISTICS

۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current		-	-	76	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	228	А
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 38 \text{ A}$	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 38 A,$	-	207	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	di <sub>F</sub> /dt = 100 A/µs	-	1.5	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

#### **TYPICAL CHARACTERISTICS**

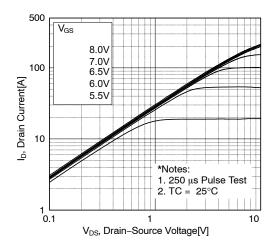


Figure 1. On–Region Characteristics

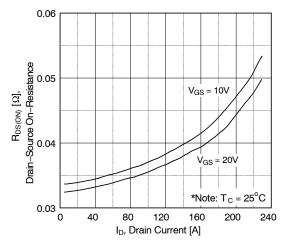


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

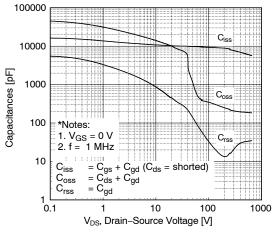


Figure 5. Capacitance Characteristics

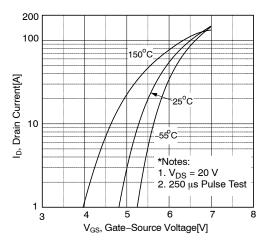


Figure 2. Transfer Characteristics

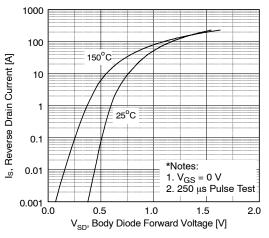


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

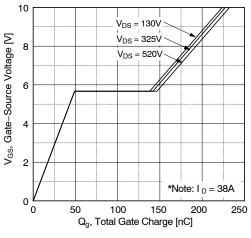


Figure 6. Gate Charge Characteristics

## **TYPICAL CHARACTERISTICS**

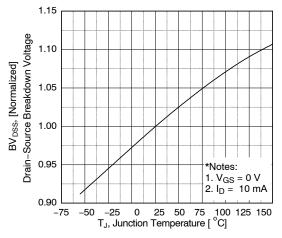


Figure 7. Breakdown Voltage Variation vs. Temperature

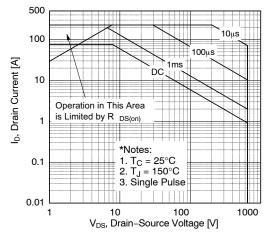


Figure 9. Maximum Safe Operating Area

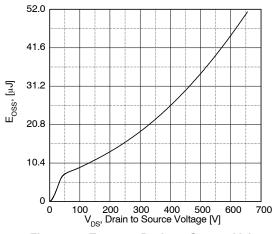


Figure 11. Eoss vs. Drain to Source Voltage

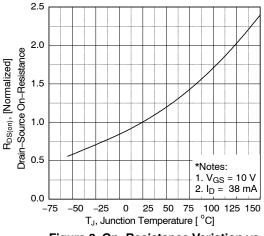
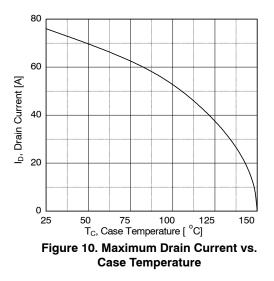


Figure 8. On–Resistance Variation vs. Temperature



# **TYPICAL CHARACTERISTICS**

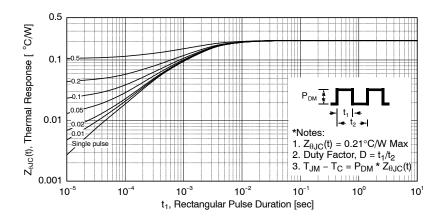
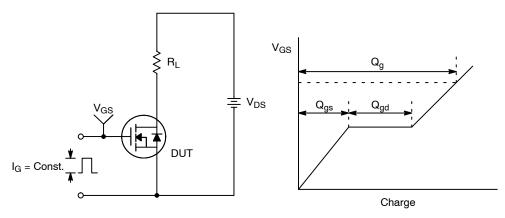


Figure 12. Transient Thermal Response Curve





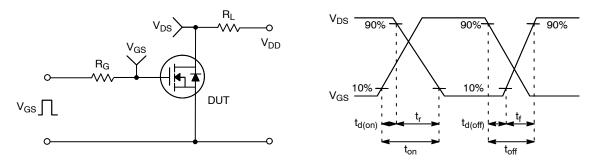


Figure 14. Resistive Switching Test Circuit & Waveforms

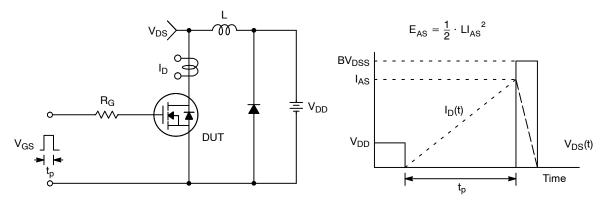


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

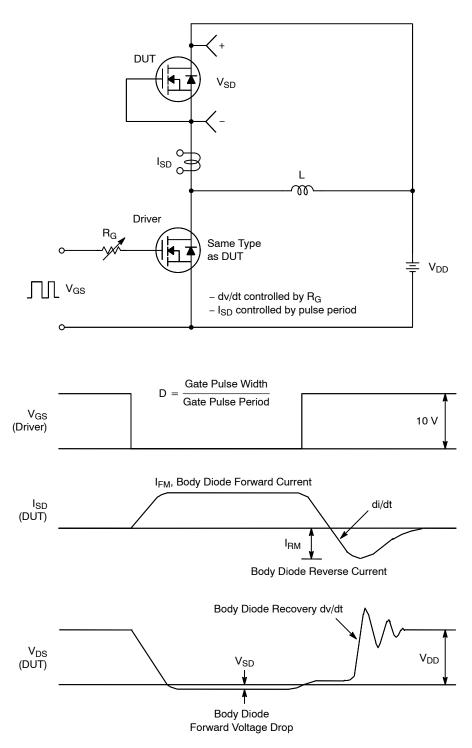


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

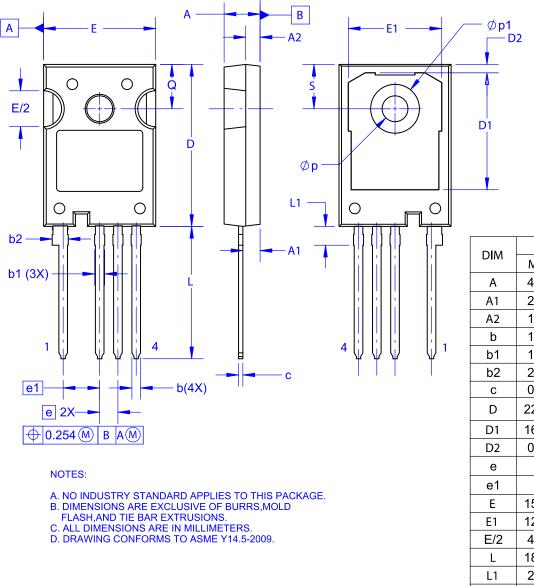
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TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MIL	LIMETER	S
DIM	MIN	NOM	MAX
А	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
С	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
е	2	2.54 BSC	2
e1	Ę	5.08 BSC	2
Е	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
р	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

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